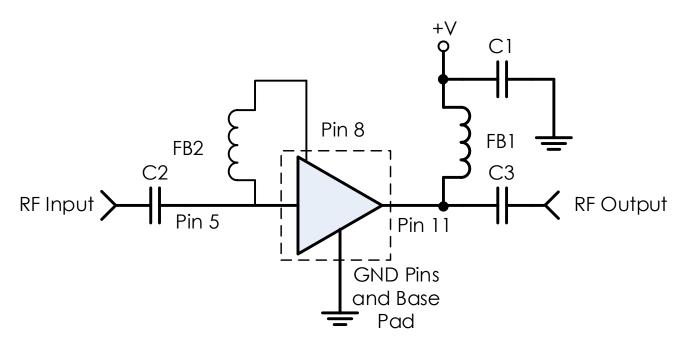


VDD on RF Out

Typical Application



Recommended Component List (or equivalent):

Part	Value	Part Number	Manufacturer
C1	0.1 uF	GRM155R71C104KA88	Murata
C2, C3	0.1 uF	0201BB104KW160	Passives Plus
FB1, FB2	-	MMZ1005A222E	TDK

Notes

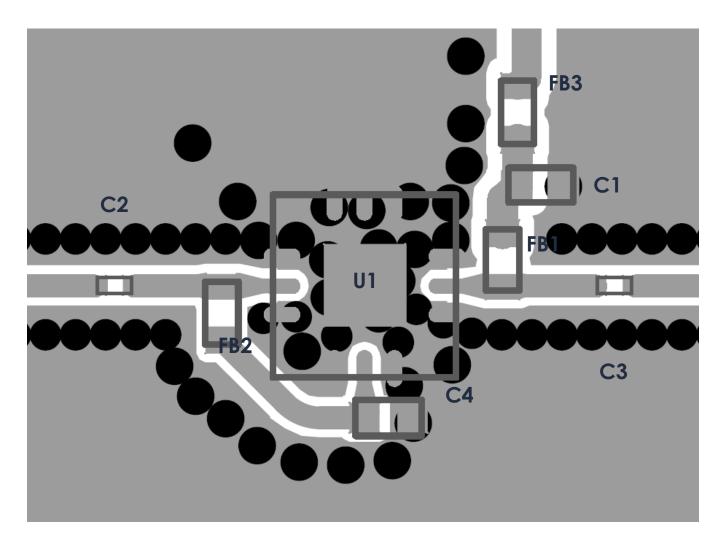
- 1. Application shown above is the minimum needed for an operational circuit.
- 2. The circuit in the recommended layout is representative of the s-parameters as available on the website.
 - a. The recommended layout adds extra components to increase power line isolation and improve performance vs frequency.
- 3. To choose the best component for FB2, Atlanta Micro recommends the following:
 - a. First, determine your desired frequency range of operation.
 - b. Next, design your output bias tee (FB1/C1 + any other components) for your desired power supply isolation and chosen frequency range.
 - c. The component used for FB2 should then be component(s) as used in your bias tee that connect to the main RF output (pin 11) line only.
 - i. This does not need to be the whole bias tee design.
 - ii. In the example above, FB2 = FB1.

To obtain price, delivery, or to place an order contact <u>sales@atlantamicro.com</u> Atlanta Micro Inc., 3720 Davinci Ct, Suite 125, Peachtree Corners, GA 30092 • Phone: (470) 253-7640 • <u>www.atlantamicro.com</u>



VDD on RF Out

Recommended Layout



Notes:

- 1. FB3 = FB1 = MMZ1005A222E for symmetry.
- 2. C4 = C1 = GRM155R71C104KA88. C4 recommended for better performance across frequency.
- 3. Recommended input trace is grounded coplanar waveguide, 50 ohms.
- 4. IC and RF input / output should be via fenced.
- 5. Vias should be placed under IC and GND pads.
- 6. FBx and Cx may be 0201 components to minimize space used. It is not recommended to use components larger than 0402 due to extra parasitic inductance/capacitance of the larger component sizes.



VDD on RF Out

Revision History

Date	Revision Number	Notes
January 21, 2021	1	Initial Release